



POWER MODULES

IRK.170, .230, .250 SERIES

High Voltage Thyristor/Diode and Thyristor/Thyristor

FEATURES

- ❖ *Electrically isolated base plate.*
- ❖ *3000 V_{RMS} isolating voltage.*
- ❖ *Industrial standard package.*
- ❖ *Simplified mechanical designs, rapid assembly.*
- ❖ *High surge capability.*
- ❖ *Large creepage distances.*
- ❖ *Beryllium oxide substrate.*

DESCRIPTION

These IRK series of Power Modules use power thyristors/diodes in four basic configurations. The semiconductors are electrically isolated from the metal base, allowing common heatsinks and compact assemblies to be built. They can be interconnected to form single phase or three phase bridges or as AC-switches when modules are connected in anti-parallel.

These modules are intended for general purpose applications such as battery chargers, welders and plating equipment.

MAJOR RATINGS & CHARACTERISTICS

Parameters	IRK.170	IRK.230	IRK.250	Units
$I_{T(AV)}$ @ 85°C	170	230	250	A
$I_{T(RMS)}$	377	510	555	A
I_{TSM} @ 50 Hz	5100	7500	8500	A
I^2t @ 50 Hz	131	280	361	kA ² s
$I^2\sqrt{t}$	1310	2800	3610	kA ² √s
$V_{DRM} - V_{RRM}$	Up to 2200	Up to 2200	Up to 2200	V
T_J	-40 to 125			°C

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ELECTRICAL SPECIFICATION VOLTAGE RATINGS

Type Number	Voltage Code	V_{RRM} / V_{DRM} max. repetitive peak reverse and off-state voltage blocking voltage V	V_{RSM} max. non-repetitive peak reverse voltage V	I_{DRM} / I_{RRM} max. @ 130°C mA
	06	600	700	50
IRK.170	08	800	900	50
IRK.230	10	1000	1100	50
IRK.250	12	1200	1300	50
	14	1400	1500	50
	16	1600	1700	50
	18	1800	1900	50
	20	2000	2100	50
	22	2200	2300	50

ON-STATE CONDUCTION

Parameters	IRK.170	IRK.230	IRK.250	Units	Conditions
$I_{T(AV)}$ Max. average on-state current @ Case temperature	170	230	250	A	180° conduction, half sine wave
	85	85	85	°C	
$I_{T(RMS)}$ Max. RMS on-state current	377	510	555	A	as AC switch
I_{TSM} Max. peak, one cycle on-state, non-repetitive surge current	5100	7500	8500	A	t = 10ms Sinusoidal half wave, Initial $T_J = T_J$ max.
I^2t Maximum I^2t for fusing	131	280	361	kA ² s	t = 10ms Sinusoidal half wave, Initial $T_J = T_J$ max.
$I^2\sqrt{t}$ Maximum $I^2\sqrt{t}$ for fusing	1310	2800	3610	kA ² √s	t = 0.1 to 10ms. No voltage reapplied.
$V_{T(TO)}$ Threshold voltage	0.89	1.03	0.97	V	$T_J = T_J$ max.
r_t On-state slope resistance	1.34	0.77	0.60	mΩ	$T_J = T_J$ max.
V_{TM} Max. on-state voltage drop	1.60	1.59	1.44	V	$I_{TM} = \pi \times I_{T(AV)}$, $T_J = T_J$ max., 180° conduction AV. power = $V_{T(TO)} \times I_{T(AV)} + r_t \times (I_{T(RMS)})^2$
I_H Maximum holding current	500			mA	Anode supply = 12V, initial $I_T = 30A$, $T_J = 25^\circ C$
I_L Max. latching current	1000			mA	Anode supply = 12V, resistive load = 1Ω, gate pulse : 10V, 100μs, $T_J = 25^\circ C$

SWITCHING

t_d Typical delay time	1.0	1.0	1.0	μs	$T_J = 25^\circ C$ Gate current = 1A $dl/dt = 1A/\mu s$ $V_d = 0.67\% V_{DRM}$
t_r Typical rise time	2.0	2.0	2.0	μs	
t_f Typical turn-off time	50-150			μs	$I_{TM} = 300A$; $dl/dt = 15A/\mu s$; $T_J = T_J$ max.; $V_r = 50V$; $dV/dt = 20V/\mu s$; Gate 0V, 100ohm

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BLOCKING

	Parameter	170	230	250	Units	Conditions
dv/dt	Maximum critical rate of rise of off-state voltage	500			V/ μ s	$T_J = 125^\circ\text{C}$, exponential to 67% rated V_{DRM}
I_{RRM} I_{ORM}	Max. peak reverse and off-state leakage current	50			mA	$T_J = 125^\circ\text{C}$, rated V_{DRM}/V_{RRM} applied
V_{RMS}	RMS isolation voltage	3500			V	50Hz, Circuit to base, all terminal shorted, 25°C , 1sec

TRIGGERING

	Parameter	170	230	250	Units	Conditions
P_{GM}	Maximum peak gate power	10.0			W	$T_J = 125^\circ\text{C}$, $t_p \leq 5\text{ms}$
$P_{G(AV)}$	Maximum average gate power	2.0				$T_J = 125^\circ\text{C}$, $f = 50\text{Hz}$, $d\% = 50$
I_{GM}	Max. peak positive gate current	3.0			A	$T_J = 125^\circ\text{C}$, $t_p \leq 5\text{ms}$
$+V_{GM}$	Max. peak positive gate voltage	20			V	$T_J = 125^\circ\text{C}$, $t_p \leq 5\text{ms}$
$-V_{GM}$	Max. peak negative gate voltage	5.0				
I_{GT}	DC gate current required to trigger	TYP.	MAX.		mA	$T_J = 25^\circ\text{C}$ Max. required gate trigger/current / voltage are the lowest value which will trigger all units 12V anode-to-cathode applied.
		150	200			
V_{GT}	DC gate voltage required to trigger	3.0	3.0		V	$T_J = 25^\circ\text{C}$
V_{GD}	DC gate voltage not to trigger	0.25			V	$T_J = 125^\circ\text{C}$ Max. gate current / voltage not to trigger the max. value which will not trigger any unit with rated V_{DRM} anode-to-cathode applied
I_{GD}	DC gate current not to trigger	10.0			mA	
di/dt	Maximum critical rate of rise of turned-on current	100			A/ μ s	$T_J = 125^\circ\text{C}$, $I_{TM} = 400\text{A}$, rated V_{DRM} applied

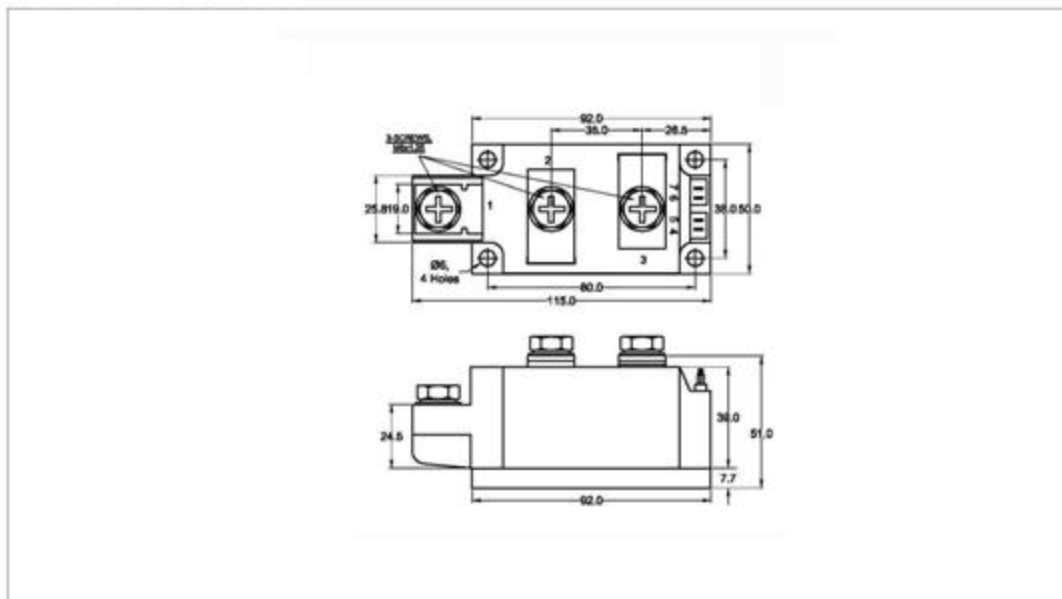
THERMAL AND MECHANICAL SPECIFICATION

	Parameter	170	230	250	Units	Conditions
T_J	Max. operating temperature range	-40 to 130			°C	
T_{stg}	Max. storage temperature range	-40 to 150				
R_{thJC}	Max. thermal resistance, junction to case	0.17	0.125	0.125	K/W	Perjunction, DC operation
	Max. thermal resistance, junction to heatsink	0.02	0.02	0.02	K/W	Mountingsurfaceflat, smooth and greased
T	Mounting torque, $\pm 10\%$	4 to 6			Nm	For Module to heatsink and busbar to Module
w t	Approximate weight	800			g	
	Case style	MAGN-A-PAK				

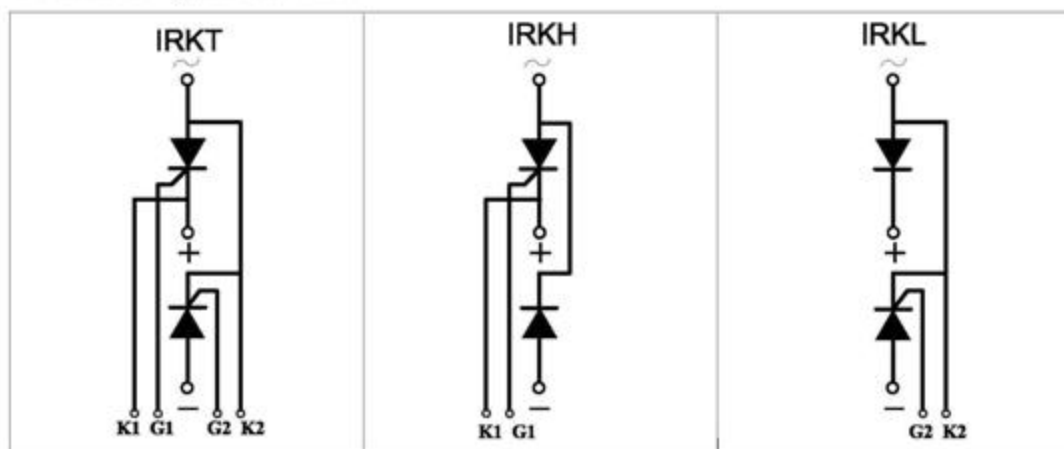
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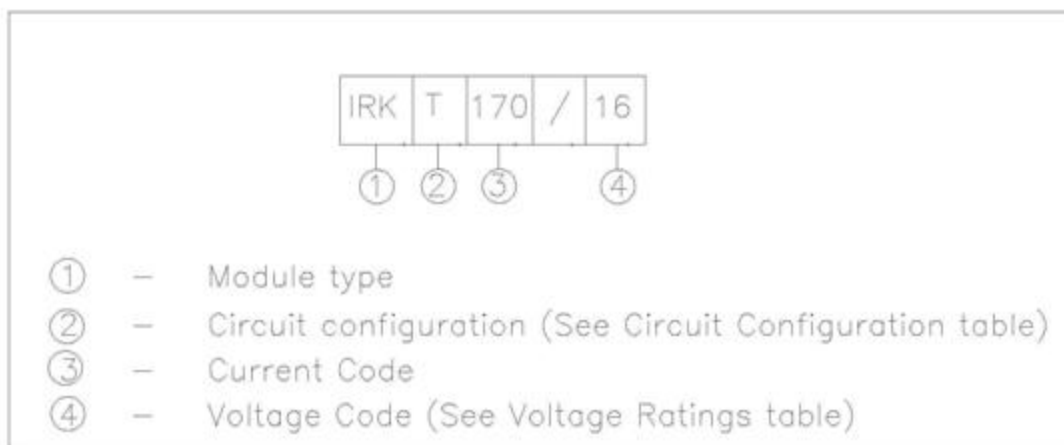
OUTLINE DIAGRAM



Circuit Configuration Table



Ordering Information Table



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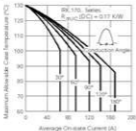


Fig 1 - Current Ratings Characteristics

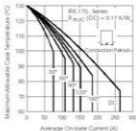


Fig 2 - Current Ratings Characteristics

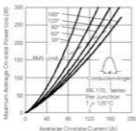


Fig 3 - On-state Power Loss Characteristics

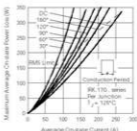


Fig 4 - On-state Power Loss Characteristics

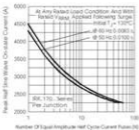


Fig 5 - Maximum Non-Repetitive Surge Current

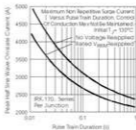


Fig 6 - Maximum Non-Repetitive Surge Current

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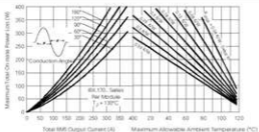


Fig 7 - On-state Power Loss Characteristics

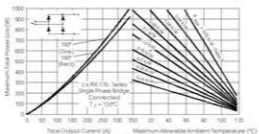


Fig 8 - On-state Power Loss Characteristics

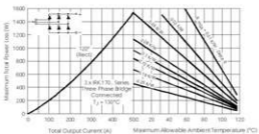


Fig 9 - On-state Power Loss Characteristics

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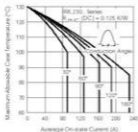


Fig 10 - Current Ratings Characteristics

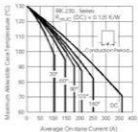


Fig 11 - Current Ratings Characteristics

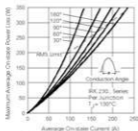


Fig 12 - On-state Power Loss Characteristics

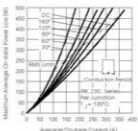


Fig 13 - On-state Power Loss Characteristics

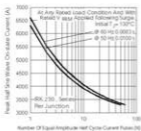


Fig 14 - Maximum Non-Repetitive Surge Current

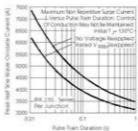


Fig 15 - Maximum Non-Repetitive Surge Current

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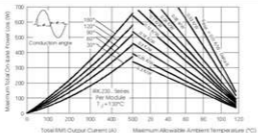


Fig. 16 - On-state Power Loss Characteristics

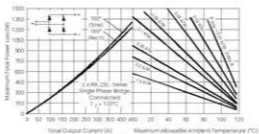


Fig. 17 - On-state Power Loss Characteristics

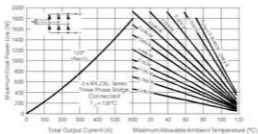


Fig. 18 - On-state Power Loss Characteristics

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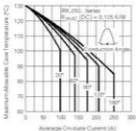


Fig 19 - Current Ratings Characteristics

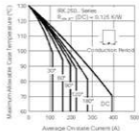


Fig 20 - Current Ratings Characteristics

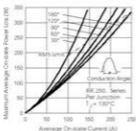


Fig 21 - On-state Power Loss Characteristics

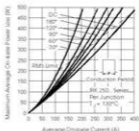


Fig 22 - On-state Power Loss Characteristics

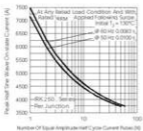


Fig 23 - Maximum Non-Repetitive Surge Current

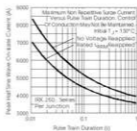


Fig 24 - Maximum Non-Repetitive Surge Current

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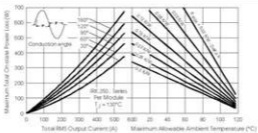


Fig. 25 - On-state Power Loss Characteristics

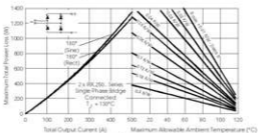


Fig. 26 - On-state Power Loss Characteristics

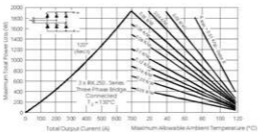


Fig. 27 - On-state Power Loss Characteristics

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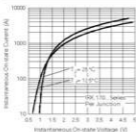


Fig. 28 - On-state Voltage Drop Characteristics

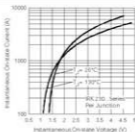


Fig. 29 - On-state Voltage Drop Characteristics

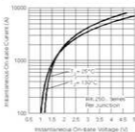


Fig. 30 - On-state Voltage Drop Characteristics

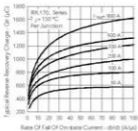


Fig. 31 - Reverse Recovery Charge Characteristics

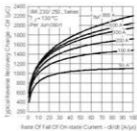


Fig. 32 - Reverse Recovery Charge Characteristics

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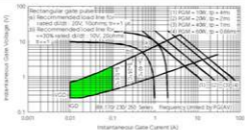


Fig. 33 - Gate Characteristics

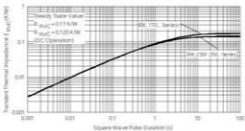


Fig. 34 - Thermal Impedance $Z_{\theta JC}$ Characteristics

Last Update :APR. 2007